APPLICA	BLE STA	NDARD									
	Operating		-55 °C to 85 °C	 }	_	e tempe	erature		-10°C TO 50°C(Packed o	onditi	on)
RATING Voltage Current		e range	ange r		Operat	range Operating or storage humidity range		+	Relative humidity 90 % MAX (Not of		
			▲ 0.3 A			Applicable cable			t=0.3±0.03mm, Gold plating		
	Current		SPEC	IFIC		VIQ.					,
17					ATIO	NO)FOLI	DEMENTO	ОТ	
	TEM PLICTION		TEST METHOD					KEQU	REMENTS	QT	AT
CONSTRUCTION General examination			nd by measuring instrumen	t.		According to drawing.			×	×	
Marking			Confirmed visually.			(note 1)				×	×
	ICAL CH	ARACTEI								1	1
Voltage proc		90 V AC f				No flas	hover or	break	down.	×	T
Insulation resistance		100 V DC	100 V DC.			50 MΩ MIN.				×	<u> </u>
Contact resi	ctonco	AC 20 m\	AC 20 mV MAX , 1 mA .							×	
Contact resistance		AC 20 III	AO 20 IIIV IVIAA , I IIIA .				100 mΩ MAX.				_
MECHAN	JICAL CE	IARACTE	 ARACTERISTICS				Including FPC bulk resistance (L=8mm)				
Vibration	TOAL OF		y 10 to 55 Hz, half amplitud	е		① No	electrica	l disco	ontinuity of 1 µs.	×	T _
		0.75 mm,	0.75 mm, for 10 cycles in 3 axial directions.				 No electrical discontinuity of 1 μs. Contact resistance: 100 mΩ MAX. 				
Shock			981 m/s ² , duration of pulse 6 ms at 3 times in 3 both axial directions.				③ No damage, crack and looseness of parts.			×	
Mechanical operation						 Contact resistance: 100 mΩ MAX. No damage, crack and looseness of parts. 			×	_	
FPC insertio	n force	Measured	Measured by applicable FPC			Insertion force : Direction of insertion			×	<u> </u>	
		,	(Thickness of FPC shall be t=0.30mm				2.6+0.14 × n N MAX (<i>note 2</i>)				
FPC retention	n force		at initial condition.) Measured by applicable FPC			(n: Number of contacts) Retention force : Direction of extraction					
i i o retermo	on loice	(Thicknes	(Thickness of FPC shall be t=0.30mm at initial condition.)			5+0.07	×n N M nber of c	IN (no	ote3)	×	
ENVIRO	NMENTA	L CHARA	CTERISTICS			,			,		1
Corrosion salt mist		Exposed for 96 h.	Exposed at 35±2 °C, 5 % salt water spray for 96 h.				\bigcirc Contact resistance: 100 m Ω MAX.				_
Rapid change of		Tempera	Temperature-55→+15 _{TO} +35→+85→+15 _{TO} +35°C			① Contact resistance: 100 mΩ MAX.			×	_	
temperature		Time				 Insulation resistance: 50 MΩ MIN. No damage, crack and looseness of parts. 					
Damp heat	Damp heat		Under 5 cycles. Exposed at 40±2 °C,				No damage, crack and looseness or parts.				 _
(steady state		Relative I	Relative humidity 90 to 95 %, 96 h.							×	
Damp heat,	cyclic		Exposed at -10 to +65 °C,			① Contact resistance: 100 mΩ MAX.				×	-
			Relative humidity 90 to 96 %, 10 cycles, TOTAL 240 h.			② Insulation resistance: 1 MΩ MIN. (At high humidity)					
						 ③ Insulation resistance: 50 MΩ MIN. (At dry) ④ No damage, crack and looseness of parts 					
1											
COUN	IT I		ON OF REVISIONS		DESIG				CHECKED		ΛTE
3 3 BEMARK		DIS-F	DIS-F-00010250 SE. YO			KOYAMA			HY. YAMAZAKI	202	
REMARK								NF. MIYAZAKI		0823	
							CHECK		YN. TAKASHITA		0823
Unlock athorwice exaction refer to IEC 60542					DESIGNED HH. MURAKAMI			20170823			
Unless otherwise specified, refer to IEC 60512.					DRAWN		HH. MURAKAMI	20170823			
			AT:Assurance Test X:Applicable Test			RAWING NO.		Ene	ELC-368163-99-0 162-**S-0. 25SHW (99)		J
HS.			CATION SHEET .ECTRIC CO., LTD.		PART NO. CODE NO.					1/2	
FORM UDOOLL 0.1		NOOL EL	COL LLLOTRIO CO., LTD.			NU.	CL580		Δ	1/4	

	SPECIFICAT	ONS		
ITEM	TEST METHOD	REQUIREMENTS	QT	АТ
Dry heat	Exposed at 85±2°C, 96 h.	① Contact resistance: 100 mΩ MAX.	×	_
Cold	Exposed at -55±3°C, 96 h.	② No damage, crack and looseness of parts	×	_
Sulphur dioxide [JIS C 60068-2-42]	Exposed at 40 ± 2 °C, Relative humidity $80\pm5\%$ 25 ± 5 ppm for 96 h.	① Contact resistance: 100 m Ω MAX.	×	_
Hydrogen sulphide [JIS C 60068-2-43]	Exposed at 40 ± 2 °C, Relative humidity $80\pm5\%$, 10 to 15 ppm for 96 h.		×	_
Solderability	Soldered at solder temperature, 245±3°C for immersion duration,3±0.3 sec.	A new uniform coating of solder shall cover a minimum of 95 % of the surface being immersed.	×	-
Resistance to soldering heat	1) Reflow soldering: Peak TMP. 250 °C MAX. Reflow TMP. over 220 °C 60 to 90 sec. Number of reflow: 2 times 2) Soldering irons: TMP. 350±10 °C for 5±1 sec.	No deformation of case of excessive looseness of the terminals. (note 4)	×	

(note 1)

This product features top-contact point.

"One Action Lock" completes FPC lock just by inserting the FPC.

Do not operate the locking-lever when inserting the FPC.

(note 2)

Do not insert the FPC to this product at an angle.

(note 3)

There's a case which FPC retention force doesn't fulfill the value, because FPC specification affects the result of FPC retention force.

Stabilize the FPC to PCB or something fixed, if pull-up or pull-down force is exepected to be applied to the FPC.

(note 4)

Blisters which may be generated on the housing do not affect product performance.

Note QT:Q	ualification Test AT:Assurance Test X:Applicable Test	DRAWIN	NG NO.	ELC-368163-99-00		
HS	SPECIFICATION SHEET	PART NO.	FH62-**S-0. 25SHW(99)			
11.0	HIROSE ELECTRIC CO., LTD.	CODE NO		CL580	Λ	2/2